



Material Content Data Sheet



Sales Product Name				1EDI60H12AH		Issued		19. January 2018	
MA#				MA001496552					
Package				PG-DSO-8-59		Weight*		287.43 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	2.885	1.00	1.00	10037	10037	
leadframe	inorganic material	phosphorus	7723-14-0	0.025	0.01		88		
		non noble metal	zinc	7440-66-6	0.101	0.04		351	
		non noble metal	iron	7439-89-6	2.018	0.70		7022	
wire	non noble metal	copper	7440-50-8	81.947	28.51	29.26	285107	292568	
		noble metal	gold	7440-57-5	0.315	0.11	0.11	1097	1097
		encapsulation	organic material	carbon black	1333-86-4	0.594	0.21		2066
encapsulation	plastics	epoxy resin	-	23.163	8.06		80589		
		inorganic material	silicondioxide	60676-86-0	174.220	60.61	68.88	606135	688793
		leadfinish	noble metal	palladium	7440-05-3	0.000	0.00		1
noble metal	silver			7440-22-4	0.000	0.00		1	
noble metal	gold			7440-57-5	0.000	0.00		2	
plating	non noble metal	nickel	7440-02-0	0.496	0.17	0.17	1727	1731	
		noble metal	palladium	7440-05-3	0.000	0.00		1	
		non noble metal	nickel	7440-02-0	0.052	0.02		182	
glue	noble metal	silver	7440-22-4	0.000	0.00		1		
		noble metal	gold	7440-57-5	0.000	0.00	0.02	1	182
		plastics	epoxy resin	-	0.402	0.14		1398	
*deviation	< 10%			1.206	0.42	0.56	4194	5592	
Sum in total:						100.00		1000000	

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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